

IPC-Flex DC



Figure shows configuration variant

IPC-Flex DC Specification

CHASSIS	Material	Galvanised steel, powder coated		
	Dimension (WxDxH)	277x252x 140 mm		
	Weight	Approx. 3,5 kg		
DETAILS	CPU	Intel® Core™ i7 6700, 3,4Ghz		
	Chipset	Intel® Q170		
	Memory	8GB DDR4		
	Graphics	Intel® HD Graphics 530		
	Storage	1x 128GB SSD		
	LAN	2x GbE (Intel® i211, i219LM)		
	Cooling	Passive		
	Expansion slots		1x PCIe x8	
			2x PCIe x4	
			1x Mini PCIe Full Size	
	Front I/O		1x DP	
		4x USB 3.0		
		2x RJ45		
		2x DSUB9 (RS232)		
		4x DIO		
		Push button / LED		
		DC IN power supply 9-36V; 16A (Phoenix DFK-MSTB 2,5/ 3-GF-5,08)		
Rear I/O	Dust filter			
AMBIENT CONDITIONS		Operating	Storage	
	Temperature	0-45° C	-10-70° C	
	Humidity	10-80 %	10-95 %	

IPC-Flex DC

Dimensionen (in mm)

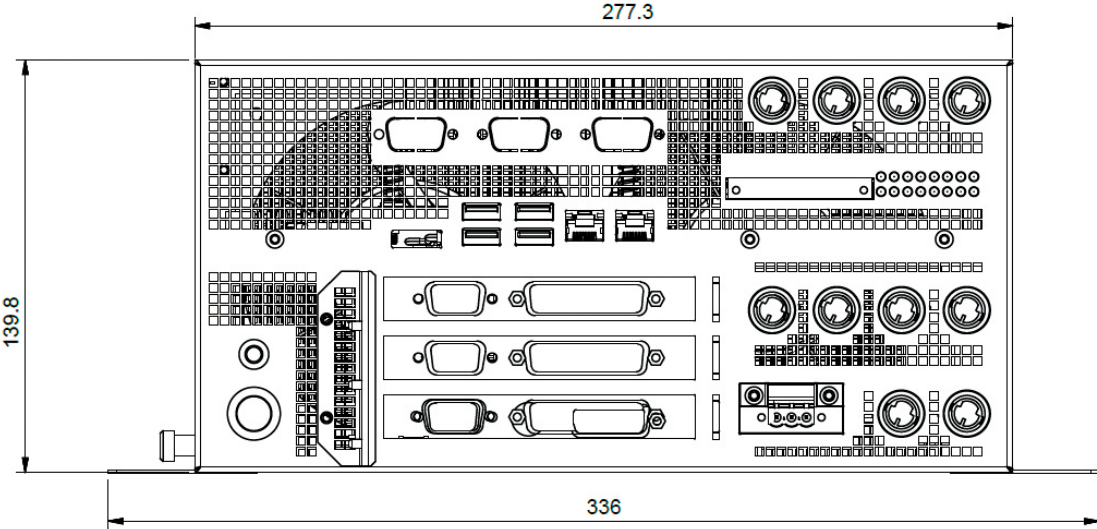
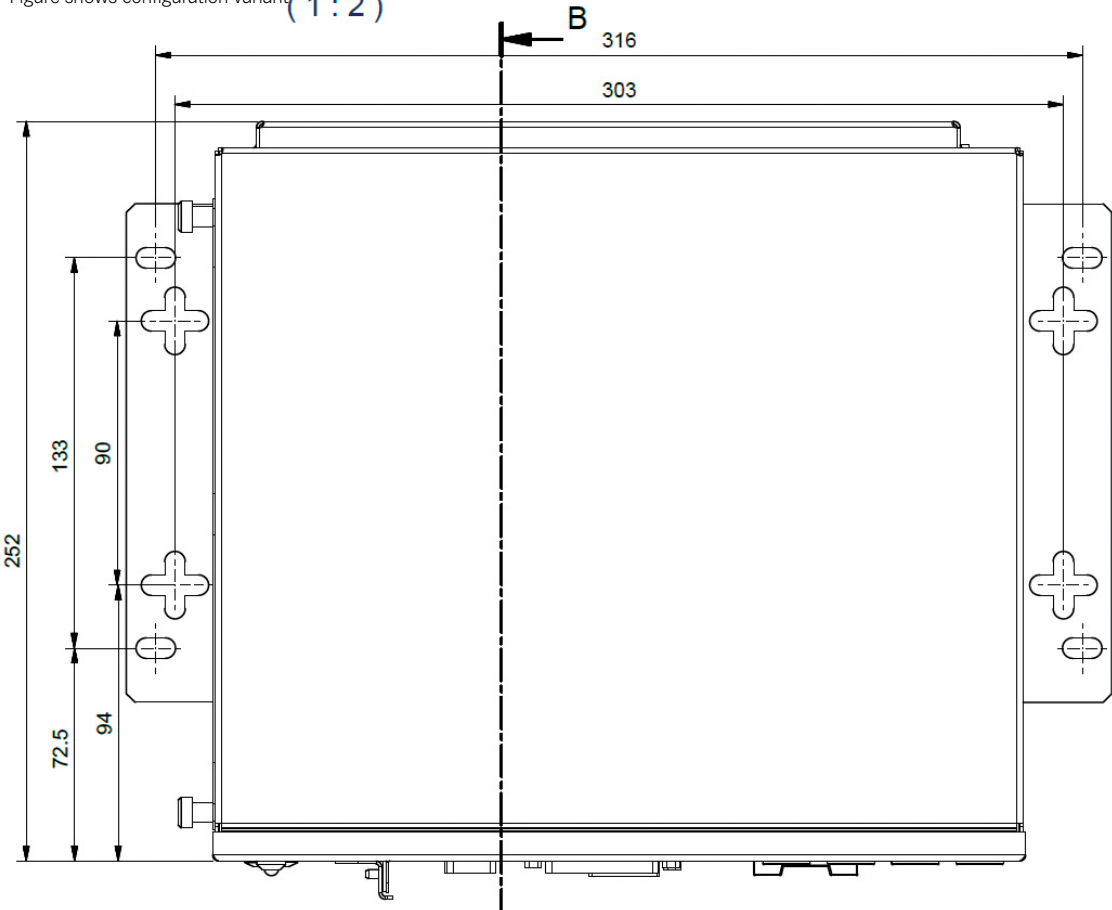


Figure shows configuration variant (1 : 2)



ds_IPC-Flex_DC_EN_rel_1.0 - specification is subject to change